

Surface Mount TVS Avalanche Diode Array

# SP0502BA, SP0503BA, SP0504BA, SP0505BA, SP0506BA

The surface mount family of arrays are designed to suppress ESD and other transient overvoltage events. These arrays are used to meet the International Electrotechnical Compatibility (IEC transient immunity standards IEC 61000-4-2 for Electrostatic Discharge Requirements). The series are used to help protect sensitive digital or analog input circuits on data, signal, or control lines with voltage levels up to 5VDC.

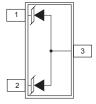
The monolithic silicon arrays are comprised of specially designed structures for transient voltage suppression(TVS). The size and shape of these structures have be tailored for transient protection. The low capacitance and clamp voltage are ideal for high speed signal line protection.

### **Ordering Information**

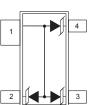
Part Number	СН	Package Type	Quantity Per Reel
SP0502BAHT	2	SOT23	3000
SP0503BAHT	3	SOT143	3000
SP0504BAHT	4	SOT23-5	3000
SP0505BAHT	5	SOT23-6	3000
SP0504BAAT	4	TSSOP-8	3000
SP0506BAAT	6	MSOP-8	4000
SP0502BAJT	2	SC70-3	3000
SP0504BAJT	4	SC70-5	3000
SP0505BAJT	5	SC70-6	3000

#### **Pinout**

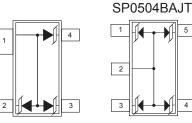




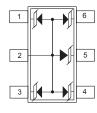
## SP0503BAHT

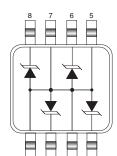


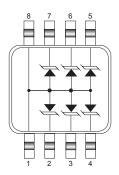
SP0504BAAT



SP0505BAHT SP0505BAJT

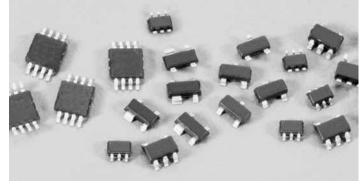






SP0506BAAT

SP0504BAHT



#### **Features**

- An Array of 2, 3, 4, 5 or 6 TVS Avalanche Diodes in a ultra small SC70, SOT-23, SOT-143, MSOP or TSSOP packages
- · ESD Capability Standards

IEC 61000-4-2, Direct Discharge	. 20kV (Level 4)
IEC 61000-4-2, Air Discharge	. 30kV (Level 4)
MIL STD 883 3015.7	30kV

- Input Protection for Applications Up to 5VDC

- Operating Temperature Range. . . . . . . . . -40°C to 85°C

## **Applications**

- · Mobile phone handsets
- Personal Digital Assistants (PDA)
- Portable handheld equipment (Laptop, Palmtop computers)
- · Computer port, keyboard (USB1.1)
- Digital still cameras
- · Digital video cameras
- MP3 players

Surface Mount TVS Avalanche Diode Array

# SP0502BA, SP0503BA, SP0504BA, SP0505BA, SP0506BA

# Electrical Specifications $T_A = +25$ °C, Unless Otherwise Specified

PARAMETER	TEST CONDITIONS	MIN	TYPICAL	MAX	UNITS
Reverse Standoff Voltage	I = 10μA	5.5	-	-	V
Reverse Standoff Leakage Current	V = 5.0V		1	100	nA
Signal Clamp Voltage					
Positive	I = 10mA	5.6	6.8	8	V
Negative	I = 10mA	-1.2	-0.8	-0.4	V
Clamp Voltage during ESD					
MIL-STD-883 Method 3015 (HBM) test					
8kV			12		V
8kV			-8		V
ESD Test Level (1)					
IEC-61000-2, Contact discharge		20			kV
MIL-STD-883 Method 3015 (HBM)		30			kV
Capacitance	2.5V @ 1Mhz		30		pF
Turn on/off Time			<1		ns
Temperature Range					
Operating		-40		85	°C
Storage		-65		150	°C
Diode Dynamic Resistance					
Forward Conduction			1.0		Ω
Reverse Conduction			1.4		Ω

#### Note:

(1) ESD voltage applied between channel pins and ground, one pin at a time; all other channel pins are open; all ground pins are grounded.

Absolute Maximum Ratings					
Parameter Rating Unit					
Storage Temperature Range	-65 to + 150	С			
Package Power Dissipation SC70 SOT23-3, SOT23-5, SOT23-6, SOT143 TSSOP, MSOP	0.2 0.225 0.5	W W W			

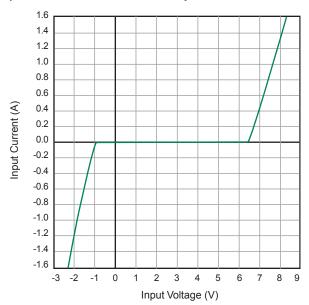


Surface Mount TVS Avalanche Diode Array

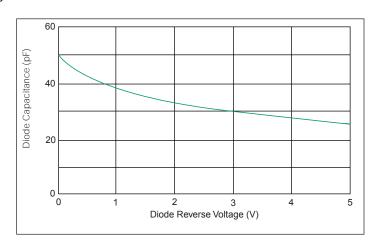
# SP0502BA, SP0503BA, SP0504BA, SP0505BA, SP0506BA

### Typical Input VI Characteristics

(Pulse-mode measurements, pulse width = 0.7 mS nominal)



# Typical Diode Capacitance vs. Reverse Voltage

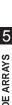


### Package Information

Mechanical Specifications				
Lead Plating	Tin-Lead			
Lead Material	Copper Alloy			
Lead Coplanarity	0.004 inches (0.102mm)			
Subsitute Material	Silicon			
Body Material	Molded Epoxy			
Flammability	UL94-V-0			

#### Notes:

- 1. All dimensions are in millimeters.
- 2. Dimensions include solder plating.
- 3. Dimensions are exclusive of mold flash & metal burr.
- 4. All specifications comply to JEDEC SPEC MO-203 ISSUE A.
- 5. Blo is facing up for mold and facing down for trim/form, i.e. reverse trim/form.
- 6. Package surface matte finish VDI 11-13.

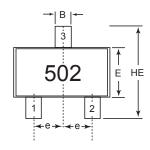




Surface Mount TVS Avalanche Diode Array

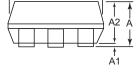
# SP0502BA, SP0503BA, SP0504BA, SP0505BA, SP0506BA

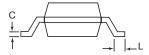
## **Outline Drawings**



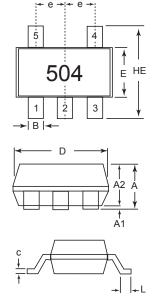


Package	SC70-3				
Pins	3				
JEDEC		MO-203	Issue A		
	m	m	incl	hes	
	min	max	min	max	
Α	0.80	1.10	0.031	0.043	
A1	0.00	0.10	0.00	0.004	
A2	0.70	1.00	0.028	0.039	
В	0.15	0.30	0.006	0.012	
С	0.08	0.25	0.003	0.010	
D	1.85	2.25	0.073	0.089	
E	1.15	1.35	0.045	0.053	
е	0.66	BSC	0.026	BSC	
HE	2.00	2.40	0.079	0.094	
L	0.26	0.46	0.010	0.018	





### SP0504BAJT - SC70-5

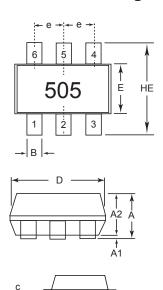


Package	SC70-5			
Pins		Ę	5	
JEDEC		MO-203	Issue A	
	m	m	incl	hes
	min	max	min	max
Α	0.80	1.10	0.03	0.043
A1	0.00	0.10	0.00	0.004
A2	0.70	1.00	0.028	0.039
В	0.15	0.30	0.006	0.012
С	0.08	0.25	0.003	0.010
D	1.85	2.25	0.073	0.089
E	1.15	1.35	0.045	0.053
е	0.65	BSC	0.026	BSC
HE	2.00	2.40	0.079	0.094
L	0.26	0.46	0.010	0.018

Surface Mount TVS Avalanche Diode Array

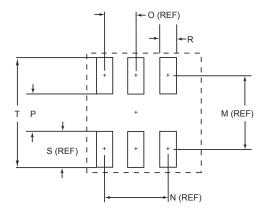
# SP0502BA, SP0503BA, SP0504BA, SP0505BA, SP0506BA

### **Outline Drawings**



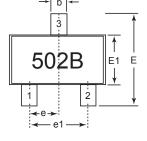
## SP0505BAJT - SC70-6

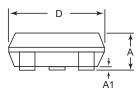
Recommended Pad Layout

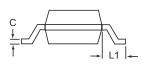


Package	SC70-6				
Pins	5				
JEDEC		MO-203	Issue A		
	m	m	incl	nes	
	min	max	min	max	
Α	0.80	1.10	0.031	0.043	
A1	0.00	0.10	0.00	0.004	
A2	0.70	1.00	0.028	0.039	
В	0.15	0.30	0.006	0.012	
С	0.08	0.25	0.003	0.010	
D	1.85	2.25	0.073	0.089	
E	1.15	1.35	0.045	0.053	
е	0.65	BSC	0.026 BSC		
HE	2.00	2.40	0.079	0.094	
L	0.26	0.46	0.010	0.018	
М	-	1.60	-	0.063	
N	-	1.30	-	0.052	
0	-	0.65	-	0.026	
Р	-	0.70	-	0.058	
R	-	0.35	-	0.014	
S	-	0.90	-	0.035	
Т	-	2.50	-	0.098	

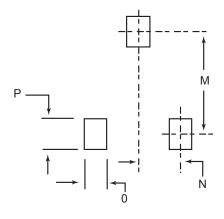
### SP0502BAHT - SOT23







Recommended Pad Layout



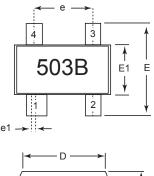
Package		SOT23				
Pins		3				
JEDEC		то-	236			
	m	m	inc	hes		
	min	max	min	max		
Α	0.89	1.12	0.035	0.044		
A1	0.01	0.1	0.0004	0.004		
b	0.3	0.5	0.012	0.020		
С	0.08	0.2	0.003	0.008		
D	2.8	3.04	0.110	0.120		
E	2.1	2.64	0.083	0.104		
E1	1.2	1.4	0.047	0.055		
е	0.95	BSC	0.95	BSC		
e1	1.90	BSC	1.90	BSC		
L1	0.54	REF	0.54	REF		
М		2.29		.090		
N		0.95		.0375		
0		0.78		.030TYP		
Р		0.78		.030TYP		

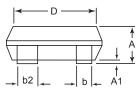


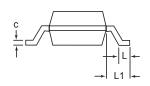
Surface Mount TVS Avalanche Diode Array

# SP0502BA, SP0503BA, SP0504BA, SP0505BA, SP0506BA

### **Outline Drawings**

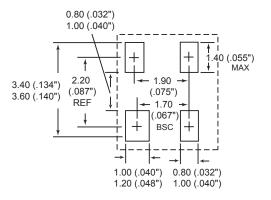






#### SP0503BAHT - SOT143

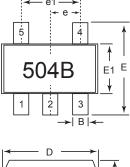
#### Recommended Pad Layout

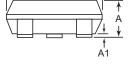


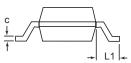
Package	SOT143				
Pins		4	4		
JEDEC		TO-	253		
	m	m	inc	hes	
	min	max	min	max	
Α	0.08	1.22	0.031	0.048	
A1	0.05	0.15	0.002	0.006	
b	0.30	0.50	0.012	0.019	
b2	0.76	0.89	0.030	0.035	
С	0.08	0.20	0.003	0.008	
D	2.80	3.04	0.110	0.119	
E	2.10	2.64	0.082	0.103	
E1	1.20	1.40	0.047	0.055	
е	1.92 BSC 0.076 BSC				
e1	0.20	BSC	0.008	BSC	
L	0.4 0.6 0.016 0.0		0.024		
L1	0.550	REF	0.022	REF	

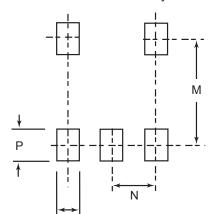
### SP0504BAHT - SOT23-5

Recommended Pad Layout







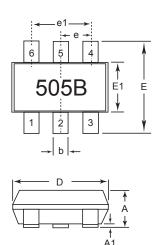


Package	SOT23-5				
Pins	5				
JEDEC		MO-	·178		
	m	m	incl	nes	
	min	max	min	max	
Α	-	1.45	-	0.057	
A1	0	0.15	0	0.006	
b	0.3	0.5	0.012	0.020	
С	0.08	0.22	0.003	0.009	
D	2.75	3.05	0.108	0.120	
E	2.6	3.0	0.102	0.118	
E1	1.45	1.75	0.057	0.069	
е	0.95	BSC	0.95	BSC	
e1	1.90	BSC	1.90	BSC	
L1	0.60 REF 0.60 REF		REF		
М		2.59	.102		
N		0.95		.038	
0		0.69	.027TYP		
Р		0.99		.039TYP	

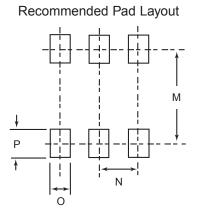
Surface Mount TVS Avalanche Diode Array

# SP0502BA, SP0503BA, SP0504BA, SP0505BA, SP0506BA

## **Outline Drawings**

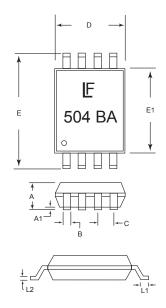


### SP0505BAHT - SOT23-6



Package	SOT23-6				
Pins	6				
JEDEC		MO	-178		
	m	m	inc	hes	
	min	max	min	max	
Α	-	1.45	-	0.057	
A1	0	0.15	0	0.006	
b	0.3	0.5	0.012	0.020	
С	0.08	0.22	0.003	0.009	
D	2.75	3.05	0.108	0.120	
Е	2.6	3.0	0.102	0.118	
E1	1.45	1.75	0.057	0.069	
е	0.95	BSC	0.95 BSC		
e1	1.90	BSC	1.90	BSC	
L1	0.60	REF	0.60	REF	
М		2.59		.102	
N		0.95		0.038	
0	0.69			.027TYP	
Р		0.99		.039TYP	
Pp@70°C		.22	5W		

### SP0504BAAT - TSSOP-8



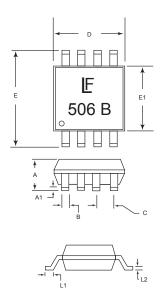
Package	TSSOP-8				
	mm		inches		
	min	max	min	max	
D	2.90	3.10	.144	.122	
Е	6.40 REF		.252 REF		
E1	4.29	4.50	.17	.18	
Α	1.194 REF		.047 REF		
A1	0.051	0.152	.002	0.006	
В	-	0.30	-	.12TYP	
С	-	0.66	-	.26TYP	
L1	0.51	0.76	.020	.030	
L2	0.102	0.203	.004	.008	



Surface Mount TVS Avalanche Diode Array

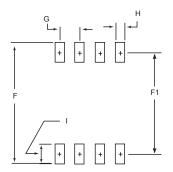
# SP0502BA, SP0503BA, SP0504BA, SP0505BA, SP0506BA

## Outline Drawings



SP0506BAAT - MSOP-8

Recommended Pad Layout



Package	MSOP-8				
	mm		inches		
	min	max	min	max	
D	2.90	3.10	.144	.122	
E	4.78	4.98	.188	.196	
E1	2.90	3.10	.114	.122	
Α	0.87	1.17	.034	.046	
A1	0.05	0.25	.002	0.10	
В	-	0.30TYP	-	.12TYP	
С	-	0.65TYP	-	.25TYP	
L1	0.52	0.54	.017	.025	
L2	-	0.18TYP	-	.007TYP	
F	-	5.28	-	.208	
F1	-	4.24	-	.167	
G	-	0.65	-	.0256	
Н	-	0.38	-	.015	
I	-	1.04	-	.041	